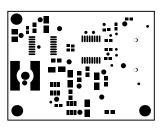
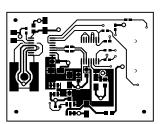


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00561	REV: E1	SUN REV	: Not In VersionControl
LAYER NAME = Top Overlay				
PLOT NAME = Top Overlay	GENERATED : 6/17/2	2015 9: 06: 30	AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00561	REV: E1	SUN REV	: Not In VersionControl
LAYER NAME = Top Solder				
PLOT NAME = Top Solder Mask	GENERATED : 6/17/2	9:06:33	AM	TEXAS INSTRUMENTS



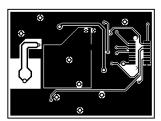
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00561	REV: E1	SUN REV	:Not In VersionControl
LAYER NAME = Top Layer				
PLOT NAME = Top Layer	GENERATED : 6/17/2	2015 9: 06: 35	AM	TEXAS INSTRUMENTS



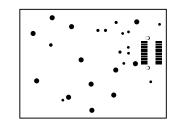
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00561	REV: E1	SUN REU	: Not In VersionControl
LAYER NAME =				
PLOT NAME = MidLayer1	GENERATED : 6/17/2	2015 9: 06: 38	AM	TEXAS INSTRUMENTS



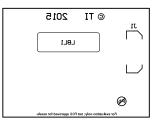
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00561	REV: E1	SUN REU:	Not In VersionControl
LAYER NAME =				
PLOT NAME = MidLayer2	GENERATED : 6/17/2	9: 06: 40	AM	TEXAS INSTRUMENTS



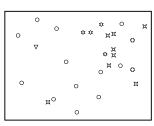
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00561	REV: E1	SUN REV:	Not In VersionControl
LAYER NAME = Bottom Layer				
PLOT NAME = Bottom Layer	GENERATED : 6/17/2	9: 06: 43	AM	TEXAS INSTRUMENTS



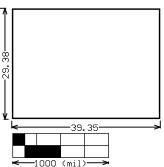
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00561	REV: E1	SUN REV	: Not In VersionControl
LAYER NAME = Bottom Solder				
PLOT NAME = Bottom Solder Mask	GENERATED : 6/17/2	015 9: 06: 46	AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00561	REV: E1	SUN REV	: Not In VersionControl
LAYER NAME = Bottom Overlay				
PLOT NAME = Bottom Overlay	GENERATED : 6/17/2	2015 9: 06: 48	AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00561	REV: E1	SUN REU	: Not In VersionControl
LAYER NAME = Drill Drawing				
PLOT NAME = Drill Drawing	GENERATED : 6/17/2	015 9: 06: 51	AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00561	REV: E1	SUN REV	: Not In VersionControl
LAYER NAME = M2 Board Dimensions				
PLOT NAME = Board Dimensions	GENERATED : 6/17/2	015 9: 06: 53	AM	TEXAS INSTRUMENTS

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